Vishay Foil Resistors





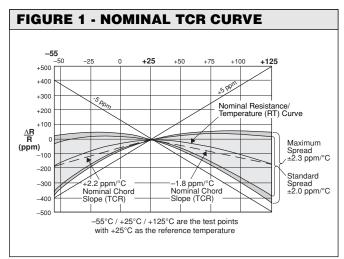
The VSM1506 Discrete Precision Chip Resistor uses the Bulk Metal® Foil (BMF) Technology for the resistance element. The BMF provides inherently a low and predictable temperature coefficient of resistance (TCR) and remarkable load life stability for precision analog applications. The predictable TCR variation is independent of value, date code, time and is expressed via the curve shown below.

The VSM1506 has a newly designed, robust termination which insures safe handling during the manufacturing process as well as providing stability during the multiple thermal cyclings it will see over its service life.

The load life specification has been improved providing even greater life stability and the ohmic value has been extended from 33K to 40K Ohms.

A voltage divider can be fashioned by using two arbitrarily selected VSM1506s; with a resultant tracking specification of < 3ppm/°C.

The VSM1506 replaces the VSM1505 for new designs.



The TCR for values < 100Ω are influenced by the termination composition and result in a deviation from this curve. Contact our application engineering department for detailed specification on low values

FEATURES

- · High Precision, Low TCR
- · Temperature Coefficient of Resistance:

Nominal TCR: + 0.6ppm/°C (0°C to + 25°C)

- 0.6ppm/°C (+ 25°C to + 60°C) + 2.2ppm/°C (- 55°C to + 25°C)
- 1.8ppm/°C (+ 25°C to + 125°Ć)
- Resistance Range: 10Ω to 40ΚΩ
- Tolerance: to ± 0.01% (See table 1)
- Load Life Stability: \pm 0.01% maximum ΔR under full rated power @ + 70°C for 2000 hours.
- Shelf Life Stability: 50ppm/year (0.005%) maximum ΔR non-hermetically sealed
- Voltage Coefficient: < 0.00001%/volt (< 0.1ppm/V)
- Current Noise: < 0.010μV(rms)/volt of applied voltage
- Non Inductive: < 3.0nH
- · Terminal Finishes Available:

Lead (Pb)-free (Sn 99.3% Cu 0.7%) Tin/Lead Alloy (Sn 62% Pb 36% Ag 2%)

TABLE 1 - TOLERANCE VERSUS RESISTANCE VALUE					
VALUE (Ω)	STANDARD TOLERANCE* (%)				
100Ω to 40KΩ	± 0.01				
50Ω to < 100Ω	± 0.05				
25Ω to $< 50\Omega$	± 0.1				
10Ω to < 25Ω	± 0.25				

*Tighter tolerances are available. Please contact Application Engineering. Soldering temperatures used during installation may cause resistance to shift up to 0.01%.

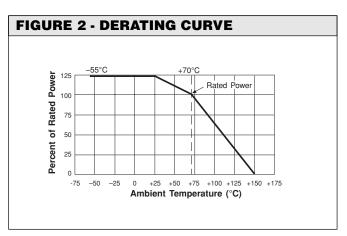
TABLE 2 - TYPICAL PERFORMANCE SPECIFICATIONS							
TEST	MIL-PRF-55342G CHARACTERISTIC E ∆R LIMITS	VSM1506 MAXIMUM ∆R LIMITS*					
Thermal Shock	± 0.10%	± 0.02%					
Low Temperature Operation	± 0.10%	± 0.02%					
Short Time Overload	± 0.10%	± 0.02%					
High Temperature Exposure	± 0.10%	± 0.03%					
Resistance to Bonding	± 0.20%	± 0.01%					
Moisture Resistance	± 0.20%	± 0.03%					
Life 2000 hours @ + 70°C	± 0.50%	± 0.01%					
Power @ + 70°C (mW)	100						
Maximum Voltage (V)	63						
Maximum Weight (mg)	12						

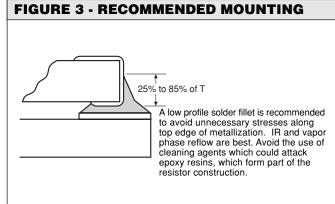
^{*}As shown + 0.01 Ohms to allow for measurement errors at low values.

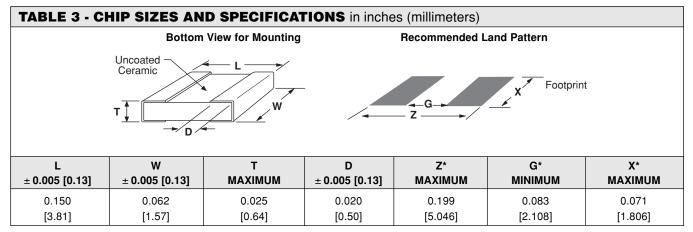
SALE



Bulk Metal® Foil Technology Vishay Foil Resistors Discrete High Precision Surface Mount Chip Resistor







^{*}Land Pattern Dimensions are per IPC-782

TABLE 4 - ORDERING INFORMATION										
MODEL	CHIP SIZE	RESISTANCE VALUE			TOLERANCE	TERMINATION	PACKAGING			
VSM	1506	RESISTANCE RANGE	LETTER DESIGNATOR	MULTIPLIER FACTOR	T ± 0.01% Q ± 0.02% A ± 0.05%	S - Lead (Pb)-free B - Tin/Lead	T = Tape and Reel W = Waffle			
		5Ω to < 1KΩ R x 1.0 Example: 249R00 = 249Ω		B ± 0.1% C ± 0.25%		Pack				
		1K to 40K Exai	K mple: 10K000 = 10.	x 10 ³ 0ΚΩ	D ± 0.5% F ± 1.0%					

SALES

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